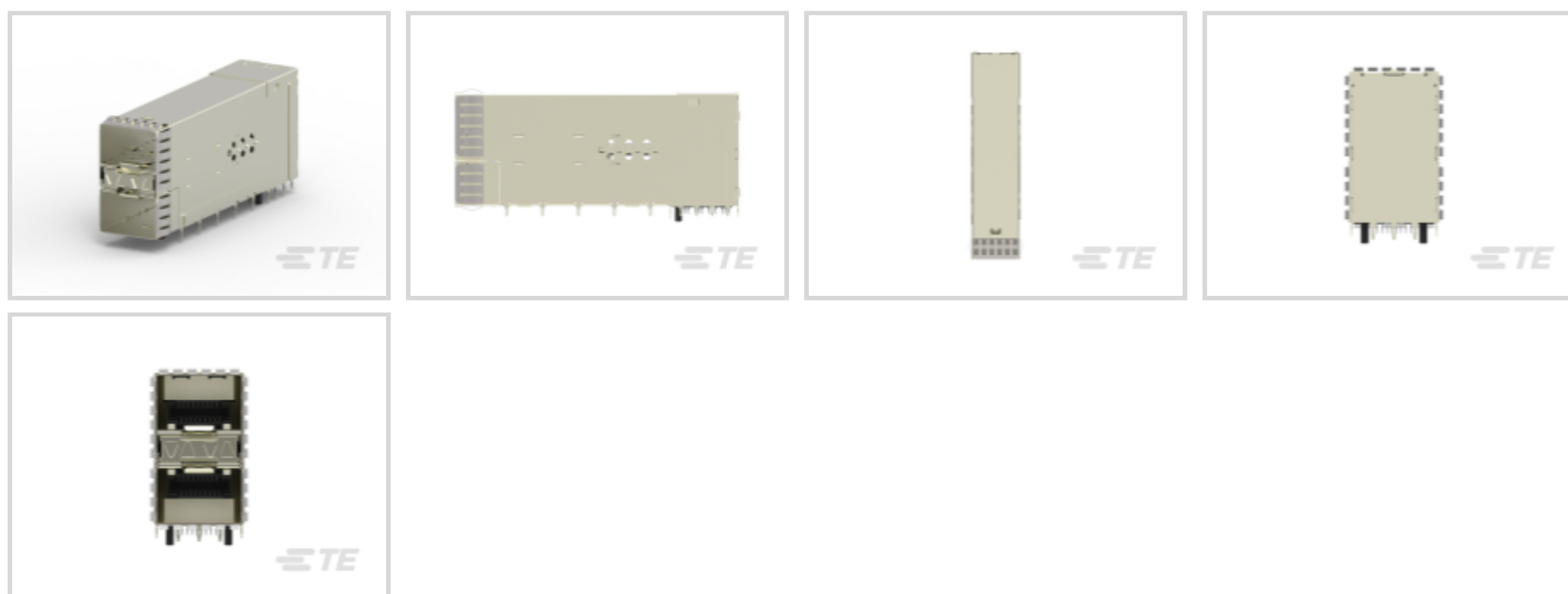




TE Internal #: 2198318-6
 SFP, SFP+ & zSFP+, Cage Assembly with Integrated Connector,
 Data Rate (Max) 32 Gb/s, External Springs, zSFP+ Thermally
 Enhanced, With Lightpipe, 2 x 1

[View on TE.com >](#)

Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > zSFP+ Stacked Cage Assembly: EMI Spring



Pluggable I/O Product Type: **Cage Assembly with Integrated Connector**

Data Rate (Max): **32 Gb/s**

EMI Containment Feature Type: **External Springs**

Pluggable I/O Applications: **zSFP+ Thermally Enhanced**

Lightpipe Options: **With Lightpipe**

[All zSFP+ Stacked Cage Assembly: EMI Spring \(45\)](#)

Features

Product Type Features

Form Factor	zSFP+ Stacked (SFP28)
Cage Type	Stacked
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Lightpipe Options	With Lightpipe
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Port Matrix Configuration	2 x 1
Lightpipe Configuration	Quad Triangular (Inner & Outer)
Lightpipe Style	Standard
Number of Ports	2
Number of Positions	40



Electrical Characteristics

Data Rate (Max)	32 Gb/s
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Contact Features

Tail Plating Material	Tin
Contact Mating Area Plating Material Thickness	.76 μ m[29.92 μ m]
Contact Mating Area Plating Material	Gold or Gold Flash over Palladium Nickel

Termination Features

Termination Post & Tail Length	1.8 mm[.07 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Cage Material	Nickel Silver Alloy
Centerline (Pitch)	.8 mm[.032 in]

Dimensions

PCB Thickness (Recommended)	1.5 mm[.059 in]
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Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application

Heat Sink Compatible	No
For Use With Pluggable I/O Products	zSFP+ SMT Connector
Pluggable I/O Applications	zSFP+ Thermally Enhanced
Circuit Application	Signal

Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Tray
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Other

EMI Containment Feature Type	External Springs
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Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # CAT-C11-N490333
QSFP28-Four SFP+ Cable Assembly: 30 AWG



TE Part # CAT-C11-N490325
QSFP28-Four SFP+ Cable Assembly: 26 AWG



TE Part # 2334985-2
SFP28 DIRECT ATTACH CA, 1M, 32AWG



TE Part # CAT-C11-N4901114
SFP28 to SFP28 Cable Assembly: 30 AWG



TE Part # CAT-C11-N49011
SFP28 to SFP28 Cable Assembly: 26 AWG



TE Part # CAT-Q17-N49011
QSFP56-Four SFP56 Cable Assembly: 30 AWG



TE Part # CAT-Q17-N490333
QSFP56-Four SFP56 Cable Assembly: 26 AWG



TE Part # 4-2821222-5
SFP56 DIRECT ATTACH CA, 2M, 30AWG



Documents

CAD Files

[3D PDF](#)

[3D](#)

Customer View Model

[ENG_CVM_CVM_2198318-6_B.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2198318-6_B.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2198318-6_B.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

[zSFP+ Interconnect Brochure](#)

English

Product Specifications

[Application Specification](#)

English

Product Environmental Compliance

[MD_2198318-6_04232018111_dmtec](#)

English

[MD_2198318-6_04232018111_dmtec](#)

English